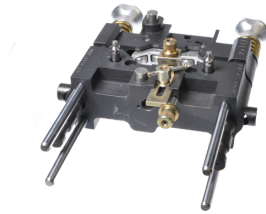


## / CAMF5/55-160-BBCF

Multifunction tool for bonded semiconductor and insulation



See online technical sheet



### / Use

CAMF SERIE tools enable the user to :

- remove the bonded semiconductor
- remove the insulation

Bonded semiconductor removal : very steady (16 ball bearings around the cable), shaping the cable round over the insulation, constant diameter over the insulation, prevent the blade from digging into the insulation

Insulation removal : back-iron that enables the user to tune the pitch of the tool thus making the rotation of the tool easy when removing the insulation

### / Advantages

- No silicon needed
- Heavy duty

### / Areas of activity

-  Cable & Connections
-  Industry
-  Production

## / Technical specifications

- **Specific tools** : Cable tools
- **Cable tools** : Cable tools
- **Areas of activity** : Cable & Connections, Industry, Production
- **Operating voltage (V)** : HTB (> 50 000 V)
- **Packaging** : Case
- **Weight (kg)** : 9,5
- **Lenght (mm)** : 700
- **Width (mm)** : 255
- **Height (mm)** : 180
- **Max diameter (mm)** : 160
- **Mini diameter (mm)** : 55
- **Cut deepness (mm)** : 35
- **Remining length of semi conductor (MIN) (mm)** : 80
- **Scoring depth MAX (mm)** : 3
- **Tools king** : Specific tools